

## N-channel 100 V, 0.02 $\Omega$ typ., 24 A STripFET™ F7 Power MOSFET in a TO-220FP package

Datasheet - production data

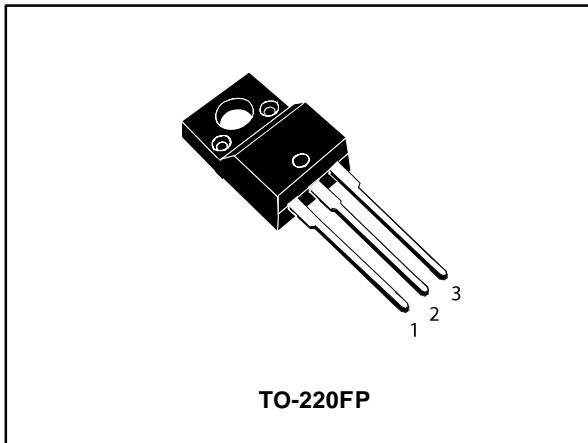
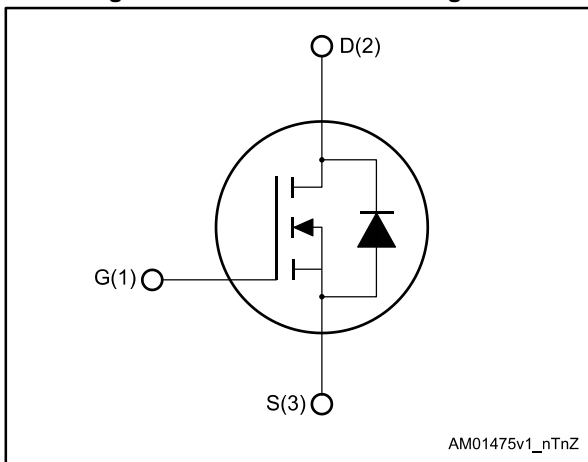


Figure 1: Internal schematic diagram



### Features

- Among the lowest  $R_{DS(on)}$  on the market
- Excellent FoM (figure of merit)
- Low  $C_{rss}/C_{iss}$  ratio for EMI immunity
- High avalanche ruggedness

### Applications

- Switching applications

### Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low on-state resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

Order code	Marking	Package	Packing
STF30N10F7	30N10F7	TO-220FP	Tube

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# 1 Electrical ratings

**Table 2: Absolute maximum ratings**

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	100	V
V <sub>GS</sub>	Gate source voltage	20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	24	A
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	16	A
I <sub>DM</sub> <sup>(1)(2)</sup>	Drain current (pulsed)	96	A
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	25	W
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T <sub>C</sub> =25 °C)	2500	V
T <sub>J</sub>	Operating junction temperature range	-55 to 175	°C
T <sub>stg</sub>	Storage temperature range		

**Notes:**

<sup>(1)</sup>Current is limited by package.

<sup>(2)</sup>Pulse width limited by safe operating area.

**Table 3: Thermal data**

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	6	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	°C/W

## 2 Electrical characteristics

( $T_C = 25\text{ °C}$  unless otherwise specified)

**Table 4: On /off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$	100			V
$I_{DSS}$	Zero gate voltage drain current	$V_{GS} = 0\text{ V}$ , $V_{DS} = 100\text{ V}$			1	$\mu\text{A}$
		$V_{GS} = 0\text{ V}$ , $V_{DS} = 100\text{ V}$ , $T_C = 125\text{ °C}^{(1)}$			100	$\mu\text{A}$
$I_{GSS}$	Gate-body leakage current	$V_{DS} = 0\text{ V}$ , $V_{GS} = +20\text{ V}$			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$	2.5		4.5	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 10\text{ V}$ , $I_D = 16\text{ A}$		0.02	0.024	$\Omega$

**Notes:**

<sup>(1)</sup>Defined by design, not subject to production test

**Table 5: Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 50\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GS} = 0\text{ V}$	-	1270	-	pF
$C_{oss}$	Output capacitance		-	290	-	pF
$C_{riss}$	Reverse transfer capacitance		-	24	-	pF
$Q_g$	Total gate charge	$V_{DD} = 50\text{ V}$ , $I_D = 32\text{ A}$ ,	-	19	-	nC
$Q_{gs}$	Gate-source charge	$V_{GS} = 10\text{ V}$	-	9	-	nC
$Q_{gd}$	Gate-drain charge	(see <a href="#">Figure 14: "Test circuit for gate charge behavior"</a> )	-	4.5	-	nC

**Table 6: Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 50\text{ V}$ , $I_D = 16\text{ A}$ , $R_G = 4.7\text{ }\Omega$ , $V_{GS} = 10\text{ V}$ (see <a href="#">Figure 13: "Test circuit for resistive load switching times"</a> )	-	12	-	ns
$t_r$	Rise time		-	17.5	-	ns
$t_{d(off)}$	Turn-off delay time		-	22	-	ns
$t_f$	Fall time		-	5.6	-	ns

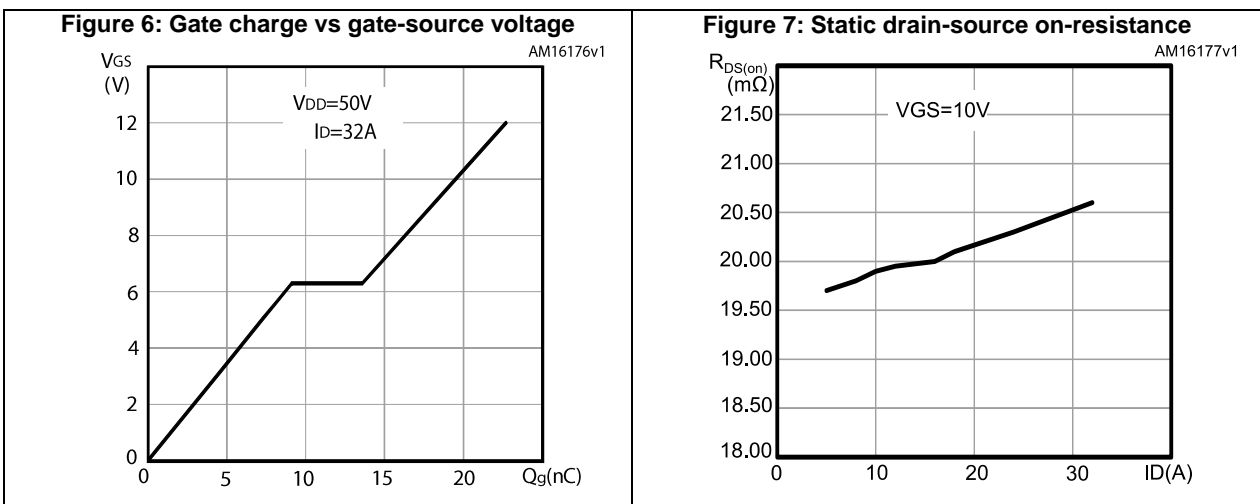
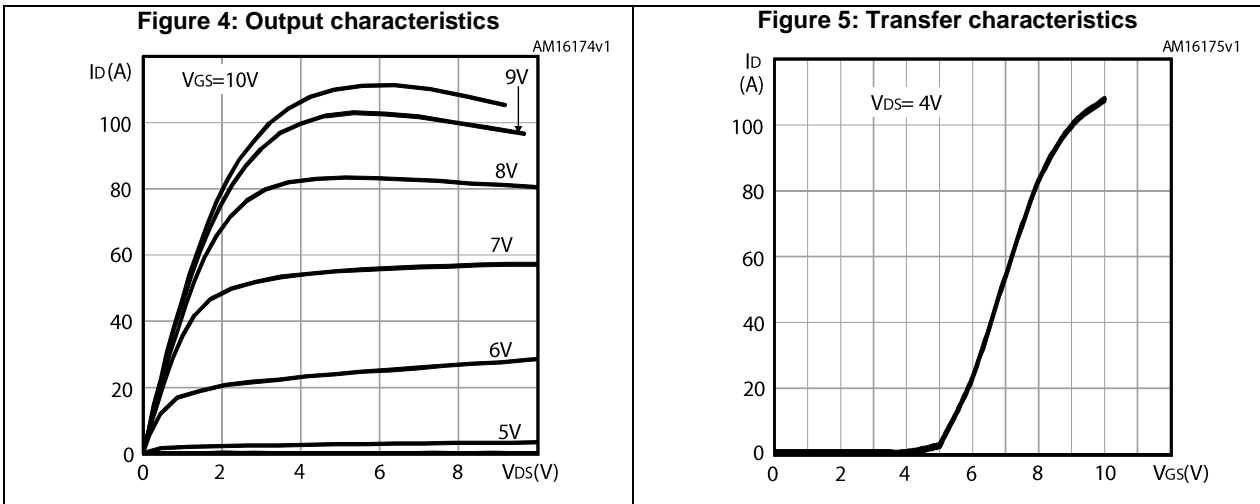
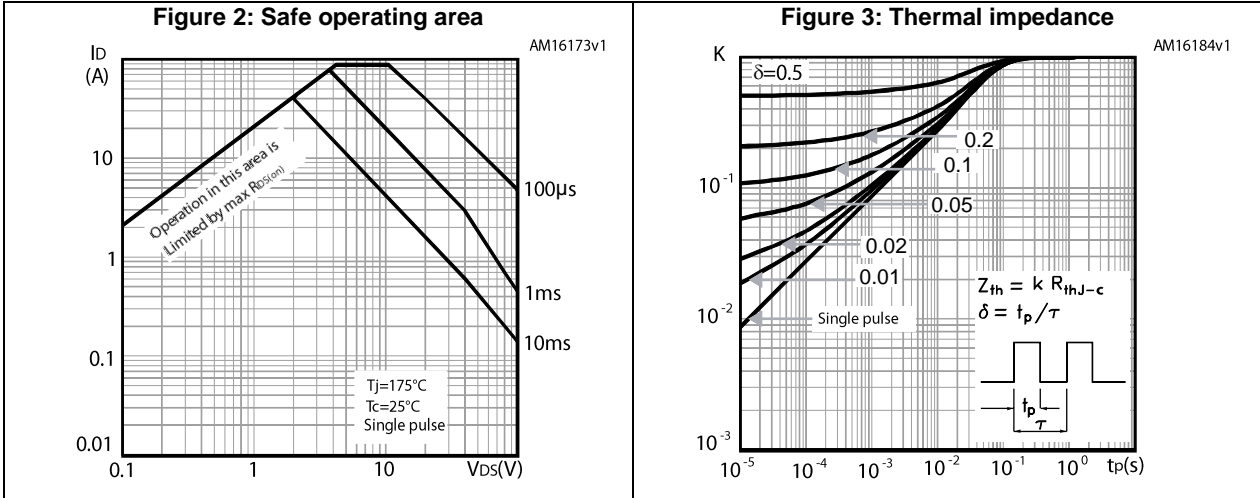
Table 7: Source-drain diode

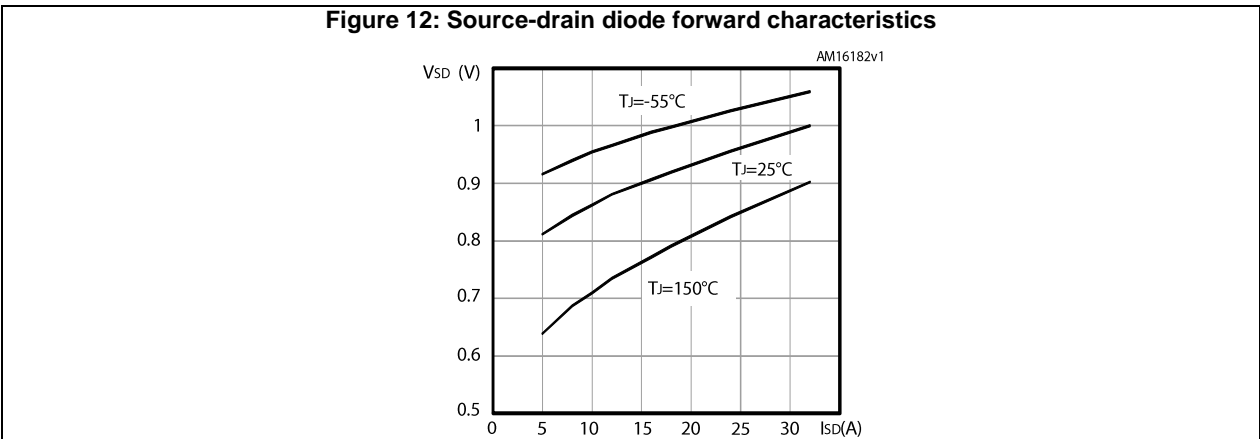
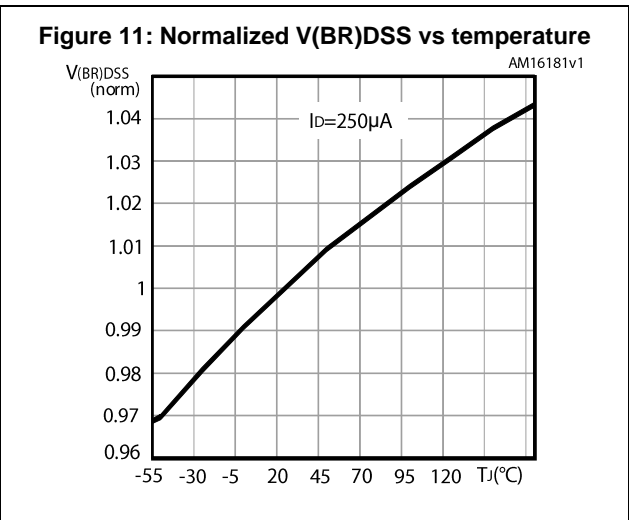
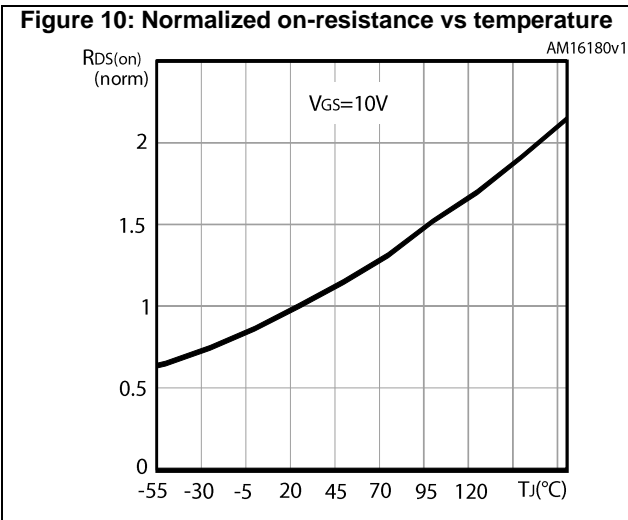
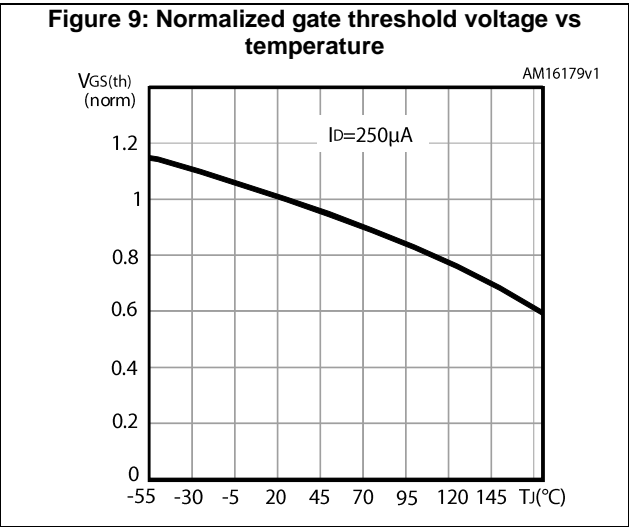
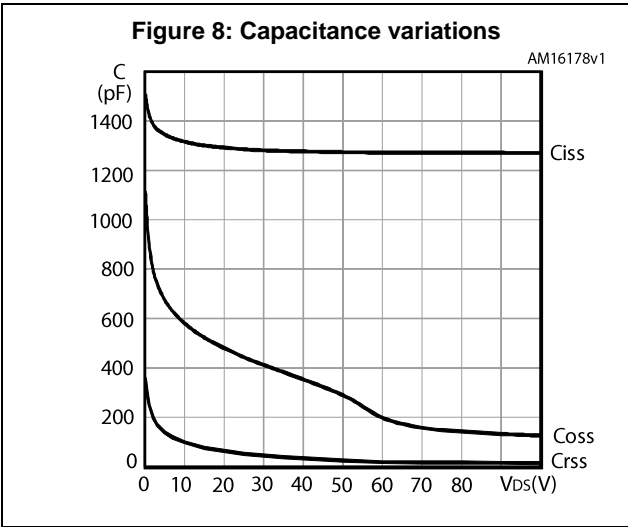
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{SD}^{(1)}$	Forward on voltage	$I_{SD} = 24 \text{ A}$ , $V_{GS} = 0$	-		1.1	V
$I_{rr}$	Reverse recovery time	$I_{SD} = 24 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$	-	41		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 80 \text{ V}$ , $T_J = 150 \text{ }^\circ\text{C}$ , (see <a href="#">Figure 15: "Test circuit for inductive load switching and diode recovery times"</a> )	-	47		nC
$I_{RRM}$	Reverse recovery current		-	2.3		A

**Notes:**

(1) Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)





### 3 Test circuits

**Figure 13: Test circuit for resistive load switching times**



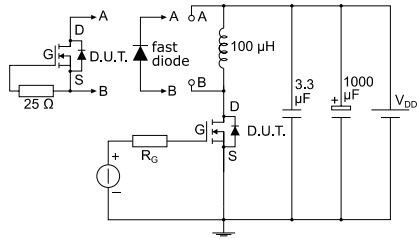
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**Figure 14: Test circuit for gate charge behavior**



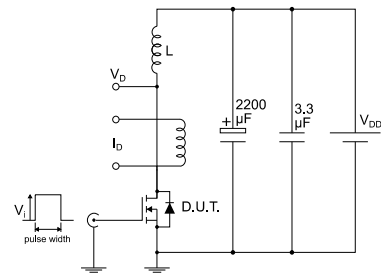
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**Figure 15: Test circuit for inductive load switching and diode recovery times**



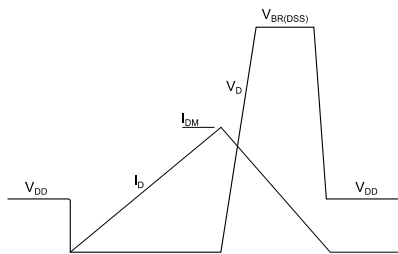
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**Figure 16: Unclamped inductive load test circuit**



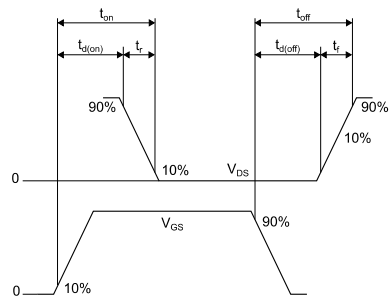
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**Figure 17: Unclamped inductive waveform**



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**Figure 18: Switching time waveform**



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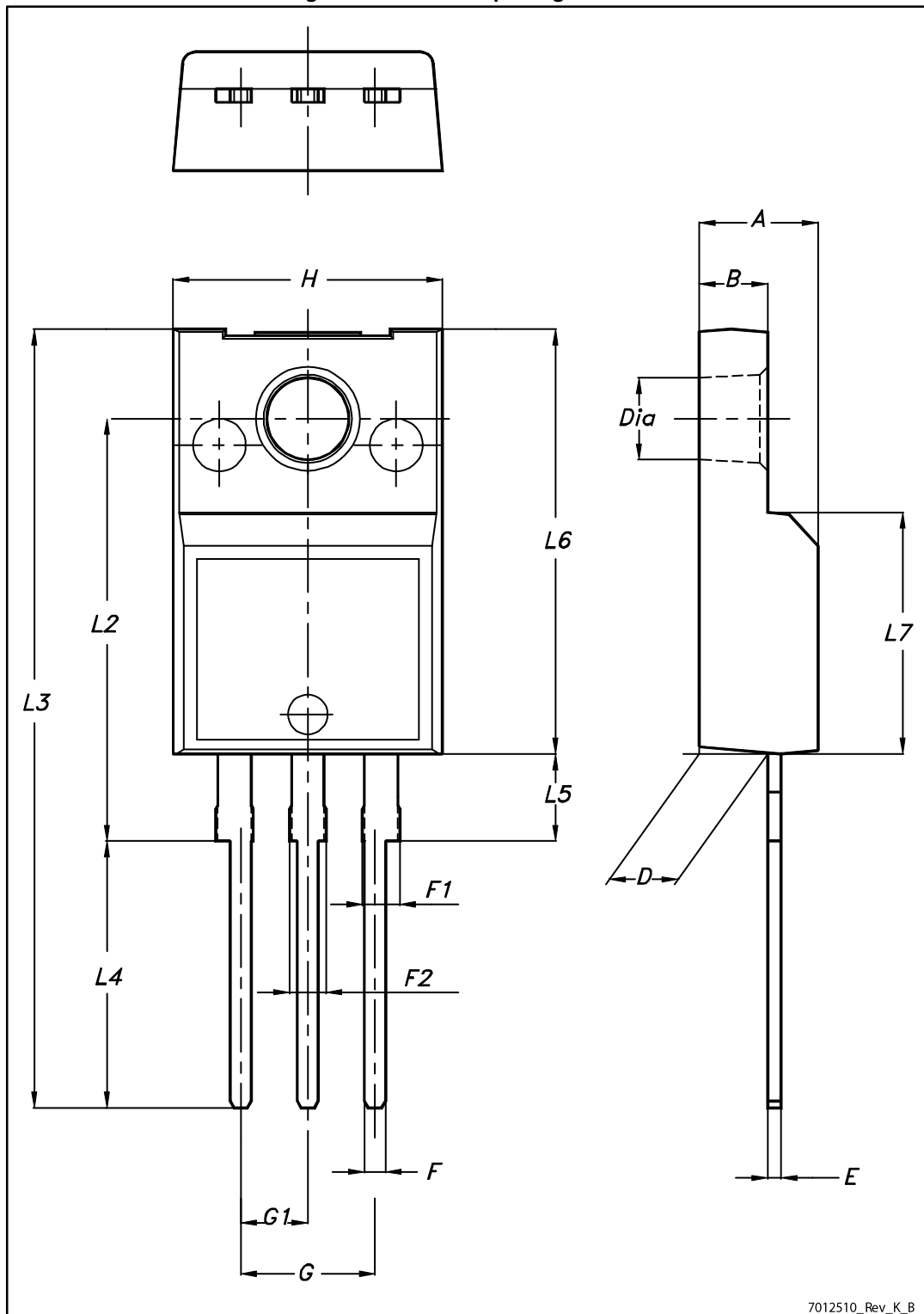


## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 4.1 TO-220FP type A package information

Figure 19: TO-220FP package outline



7012510\_Rev\_K\_B

Table 8: TO-220FP package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.4		4.6
B	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
H	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

## 5 Revision history

Table 9: Document revision history

Date	Revision	Changes
15-Sep-2016	1	First release.

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